





Certificate of Approval

AWARDED TO

SHINKO ELECTRIC INDUSTRIES CO., LTD. PLASTIC LAMINATED PACKAGE DIVISION. II ARAI PLANT

921-3, Himegawara, Myoko-shi, Niigata, 944-8588, Japan IATF USI: 3SCXRA

Bureau Veritas Certification certify that the Quality Management System of the above organisation has been audited and found to be in accordance with the requirements of

IATF 16949 - FIRST EDITION

and the applicable customer specific requirements



SCOPE

Design and manufacturing PERMITTED EXCLUSION(S)

None

PRODUCT(S) DELIVERED

Substrate for semiconductor memory device

Date Of Certification: 13-01-2023

Date Of Expiration: 12-01-2026

IATF Certificate N°: 0466474

Bureau Veritas Certification Certificate No: JP023232 - IATF

Revision: 2









Appendix to the Certificate of Approval

AWARDED TO

SHINKO ELECTRIC INDUSTRIES CO., LTD. PLASTIC LAMINATED PACKAGE DIVISION. II ARAI PLANT

921-3, Himegawara, Myoko-shi, Niigata, 944-8588, Japan IATF USI: 3SCXRA

REMOTE SUPPORT FUNCTION(S)

NAME	ADDRESS	SCOPE
SHINKO ELECTRIC INDUSTRIES CO., LTD. HEAD OFFICE	80, Oshimada-machi, Nagano-shi, Nagano, 381- 2287, Japan IATF USI: LA9YW4	Information Technologies, Training, Logistics
SHINKO ELECTRIC INDUSTRIES CO., LTD. SHINKO R&D CENTER	36, Kita-Owaribe, Nagano- Shi, Nagano, 381-0014, Japan IATF USI: L2FYXR	Calibration

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For Bureau Veritas Certification Holding, Tour ALTO, 4 place des saisons, 92400 COURBEVOIE - France (The official document is in English. Any translations of this document shall be used for reference only.)